

# SEMiX151GAL12E4s



SEMiX<sup>®</sup>1s

## Trench IGBT Modules

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### Features

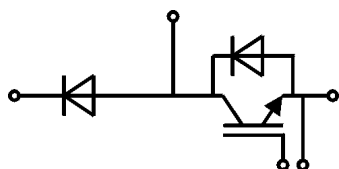
- Homogeneous Si
- Trench = Trenchgate technology
- $V_{CE(sat)}$  with positive temperature coefficient
- High short circuit capability
- UL recognised file no. E63532

### Typical Applications

- AC inverter drives
- UPS
- Electronic Welding

### Remarks

- Case temperature limited to  $T_C=125^\circ\text{C}$  max.
- Product reliability results are valid for  $T_j=150^\circ\text{C}$



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### Absolute Maximum Ratings

| Symbol                    | Conditions   | Values                    | Unit             |               |
|---------------------------|--|---------------------------|------------------|---------------|
| <b>IGBT</b>               |  |                           |                  |               |
| $V_{CES}$                 |  | 1200                      | V                |               |
| $I_C$                     | $T_j = 175^\circ\text{C}$                                    | $T_c = 25^\circ\text{C}$  | 232              | A             |
|                           |  | $T_c = 80^\circ\text{C}$  | 179              | A             |
| $I_{Cnom}$                |  | 150                       | A                |               |
| $I_{CRM}$                 | $I_{CRM} = 3 \times I_{Cnom}$                                | 450                       | A                |               |
| $V_{GES}$                 |  | -20 ... 20                | V                |               |
| $t_{psc}$                 | $V_{CC} = 800\text{ V}$                                      | $T_j = 150^\circ\text{C}$ | 10               | $\mu\text{s}$ |
|                           | $V_{GE} \leq 20\text{ V}$                                    |                           |                  |               |
|                           | $V_{CES} \leq 1200\text{ V}$                                 |                           |                  |               |
| $T_j$                     |  | -40 ... 175               | $^\circ\text{C}$ |               |
| <b>Inverse diode</b>      |  |                           |                  |               |
| $I_F$                     | $T_j = 175^\circ\text{C}$                                    | $T_c = 25^\circ\text{C}$  | 189              | A             |
|                           |  | $T_c = 80^\circ\text{C}$  | 141              | A             |
| $I_{Fnom}$                |  | 150                       | A                |               |
| $I_{FRM}$                 | $I_{FRM} = 3 \times I_{Fnom}$                                | 450                       | A                |               |
| $I_{FSM}$                 | $t_p = 10\text{ ms, sin } 180^\circ, T_j = 25^\circ\text{C}$ | 900                       | A                |               |
| $T_j$                     |  | -40 ... 175               | $^\circ\text{C}$ |               |
| <b>Freewheeling diode</b> |  |                           |                  |               |
| $I_F$                     | $T_j = 175^\circ\text{C}$                                    | $T_c = 25^\circ\text{C}$  | 189              | A             |
|                           |  | $T_c = 80^\circ\text{C}$  | 141              | A             |
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| $I_{FRM}$                 | $I_{FRM} = 3 \times I_{Fnom}$                                | 450                       | A                |               |
| $I_{FSM}$                 | $t_p = 10\text{ ms, sin } 180^\circ, T_j = 25^\circ\text{C}$ | 900                       | A                |               |
| $T_j$                     |  | -40 ... 175               | $^\circ\text{C}$ |               |
| <b>Module</b>             |  |                           |                  |               |
| $I_{t(RMS)}$              |  | 600                       | A                |               |
| $T_{stg}$                 |  | -40 ... 125               | $^\circ\text{C}$ |               |
| $V_{isol}$                | AC sinus 50Hz, $t = 1\text{ min}$                            | 4000                      | V                |               |

### Characteristics

| Symbol        | Conditions  | min.                      | typ. | max. | Unit             |
|---------------|---|---------------------------|------|------|------------------|
| <b>IGBT</b>   |   |                           |      |      |                  |
| $V_{CE(sat)}$ | $I_C = 150\text{ A}$<br>$V_{GE} = 15\text{ V}$<br>chiplevel | $T_j = 25^\circ\text{C}$  | 1.8  | 2.05 | V                |
|               |   | $T_j = 150^\circ\text{C}$ | 2.2  | 2.4  | V                |
| $V_{CE0}$     |   | $T_j = 25^\circ\text{C}$  | 0.8  | 0.9  | V                |
|               |   | $T_j = 150^\circ\text{C}$ | 0.7  | 0.8  | V                |
| $r_{CE}$      | $V_{GE} = 15\text{ V}$                                      | $T_j = 25^\circ\text{C}$  | 6.7  | 7.7  | $\text{m}\Omega$ |
|               |   | $T_j = 150^\circ\text{C}$ | 10.0 | 10.7 | $\text{m}\Omega$ |
| $V_{GE(th)}$  | $V_{GE} = V_{CE}, I_C = 6\text{ mA}$                        | 5                         | 5.8  | 6.5  | V                |
| $I_{CES}$     | $V_{GE} = 0\text{ V}$<br>$V_{CE} = 1200\text{ V}$           | $T_j = 25^\circ\text{C}$  | 0.1  | 0.3  | $\text{mA}$      |
|               |   | $T_j = 150^\circ\text{C}$ |      |      | $\text{mA}$      |
| $C_{ies}$     | $V_{CE} = 25\text{ V}$                                      |                           | 9.3  |      | $\text{nF}$      |
| $C_{oes}$     | $V_{GE} = 0\text{ V}$                                       |                           | 0.58 |      | $\text{nF}$      |
| $C_{res}$     |   |                           | 0.51 |      | $\text{nF}$      |
| $Q_G$         | $V_{GE} = -8\text{ V...} + 15\text{ V}$                     |                           | 850  |      | $\text{nC}$      |
| $R_{Gint}$    | $T_j = 25^\circ\text{C}$                                    |                           | 5.00 |      | $\Omega$         |

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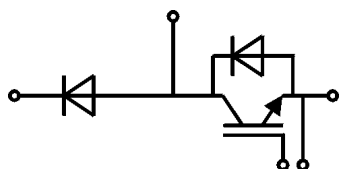
- AC inverter drives
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### Remarks

- Case temperature limited to  $T_C=125^\circ\text{C}$  max.
- Product reliability results are valid for  $T_j=150^\circ\text{C}$

### Characteristics

| Symbol                    | Conditions  | min.                      | typ.                | max. | Unit          |            |
|---------------------------|---|---------------------------|---------------------|------|---------------|------------|
| $t_{d(on)}$               | $V_{CC} = 600\text{ V}$<br>$T_j = 150^\circ\text{C}$  |                           | 204                 |      | ns            |            |
| $t_r$                     | $I_C = 150\text{ A}$<br>$T_j = 150^\circ\text{C}$   |                           | 42                  |      | ns            |            |
| $E_{on}$                  | $R_{G\ on} = 1\ \Omega$<br>$T_j = 150^\circ\text{C}$  |                           | 16.6                |      | mJ            |            |
| $t_{d(off)}$              | $R_{G\ off} = 1\ \Omega$<br>$T_j = 150^\circ\text{C}$   |                           | 468                 |      | ns            |            |
| $t_f$                     | $di/dt_{on} = 3900\text{ A}/\mu\text{s}$<br>$T_j = 150^\circ\text{C}$                             |                           | 91                  |      | ns            |            |
| $E_{off}$                 | $di/dt_{off} = 2000\text{ A}/\mu\text{s}$<br>$T_j = 150^\circ\text{C}$                            |                           | 18.4                |      | mJ            |            |
| $R_{th(j-c)}$             | per IGBT  |                           |                     | 0.19 | K/W           |            |
| <b>Inverse diode</b>      |   |                           |                     |      |               |            |
| $V_F = V_{EC}$            | $I_F = 150\text{ A}$<br>$V_{GE} = 0\text{ V}$<br>chip   | $T_j = 25^\circ\text{C}$  | 2.1                 | 2.46 | V             |            |
|                           |   | $T_j = 150^\circ\text{C}$ | 2.1                 | 2.4  | V             |            |
| $V_{F0}$                  |   | $T_j = 25^\circ\text{C}$  | 1.1                 | 1.3  | 1.5           | V          |
|                           |   | $T_j = 150^\circ\text{C}$ | 0.7                 | 0.9  | 1.1           | V          |
| $r_F$                     |   | $T_j = 25^\circ\text{C}$  | 4.3                 | 5.6  | 6.4           | m $\Omega$ |
|                           |   | $T_j = 150^\circ\text{C}$ | 6.7                 | 7.8  | 8.5           | m $\Omega$ |
| $I_{RRM}$                 | $I_F = 150\text{ A}$<br>$T_j = 150^\circ\text{C}$   |                           | 115                 |      | A             |            |
| $Q_{rr}$                  | $di/dt_{off} = 3400\text{ A}/\mu\text{s}$<br>$V_{GE} = -15\text{ V}$<br>$T_j = 150^\circ\text{C}$ |                           | 23                  |      | $\mu\text{C}$ |            |
| $E_{rr}$                  | $V_{CC} = 600\text{ V}$<br>$T_j = 150^\circ\text{C}$  |                           | 8.9                 |      | mJ            |            |
| $R_{th(j-c)}$             | per diode   |                           |                     | 0.31 | K/W           |            |
| <b>Freewheeling diode</b> |   |                           |                     |      |               |            |
| $V_F = V_{EC}$            | $I_F = 150\text{ A}$<br>$V_{GE} = 0\text{ V}$<br>chip   | $T_j = 25^\circ\text{C}$  | 2.1                 | 2.5  | V             |            |
|                           |   | $T_j = 150^\circ\text{C}$ | 2.1                 | 2.4  | V             |            |
| $V_{F0}$                  |   | $T_j = 25^\circ\text{C}$  | 1.1                 | 1.3  | 1.5           | V          |
|                           |   | $T_j = 150^\circ\text{C}$ | 0.7                 | 0.9  | 1.1           | V          |
| $r_F$                     |   | $T_j = 25^\circ\text{C}$  | 4.3                 | 5.6  | 6.4           | m $\Omega$ |
|                           |   | $T_j = 150^\circ\text{C}$ | 6.7                 | 7.8  | 8.5           | m $\Omega$ |
| $I_{RRM}$                 | $I_F = 150\text{ A}$<br>$T_j = 150^\circ\text{C}$   |                           | 115                 |      | A             |            |
| $Q_{rr}$                  | $di/dt_{off} = 3400\text{ A}/\mu\text{s}$<br>$V_{GE} = -15\text{ V}$<br>$T_j = 150^\circ\text{C}$ |                           | 23                  |      | $\mu\text{C}$ |            |
| $E_{rr}$                  | $V_{CC} = 600\text{ V}$<br>$T_j = 150^\circ\text{C}$  |                           | 8.9                 |      | mJ            |            |
| $R_{th(j-c)}$             | per diode   |                           |                     | 0.31 | K/W           |            |
| <b>Module</b>             |   |                           |                     |      |               |            |
| $L_{CE}$                  |   |                           | 16                  |      | nH            |            |
| $R_{CC+EE'}$              | res., terminal-chip   | $T_C = 25^\circ\text{C}$  | 0.7                 |      | m $\Omega$    |            |
|                           |   | $T_C = 125^\circ\text{C}$ | 1                   |      | m $\Omega$    |            |
| $R_{th(c-s)}$             | per module  |                           | 0.075               |      | K/W           |            |
| $M_s$                     | to heat sink (M5)   |                           | 3                   | 5    | Nm            |            |
| $M_t$                     |   | to terminals (M6)         | 2.5                 | 5    | Nm            |            |
|                           |   |                           |                     |      | Nm            |            |
| $w$                       |   |                           |                     | 145  | g             |            |
| <b>Temperatur Sensor</b>  |   |                           |                     |      |               |            |
| $R_{100}$                 | $T_C=100^\circ\text{C}$ ( $R_{25}=5\text{ k}\Omega$ )   |                           | $493 \pm 5\%$       |      | $\Omega$      |            |
| $B_{100/125}$             | $R_{(T)}=R_{100}\exp[B_{100/125}(1/T-1/T_{100})]$ ;<br>$T[\text{K}]$ ;                            |                           | $3550$<br>$\pm 2\%$ |      | K             |            |



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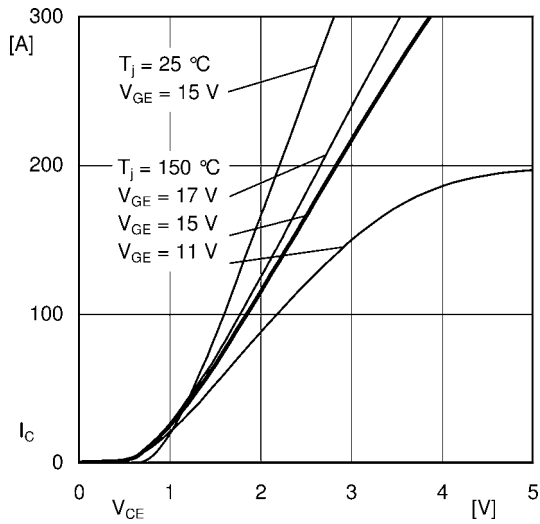


Fig. 1: Typ. output characteristic, inclusive  $R_{CC'+EE'}$

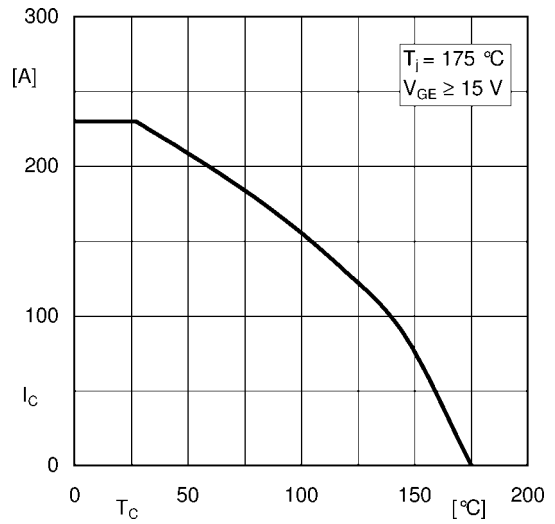


Fig. 2: Rated current vs. temperature  $I_C = f(T_C)$

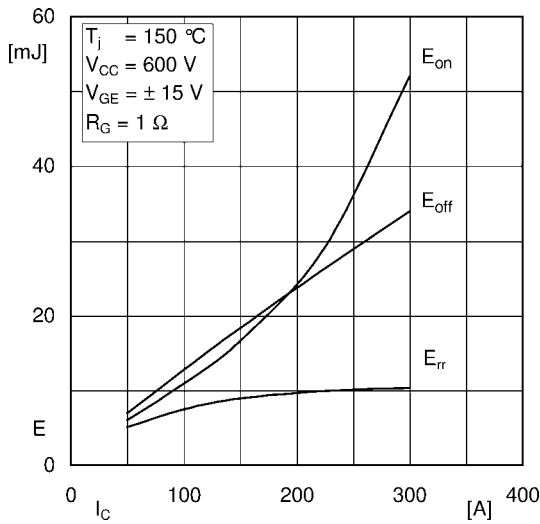


Fig. 3: Typ. turn-on /-off energy =  $f(I_C)$

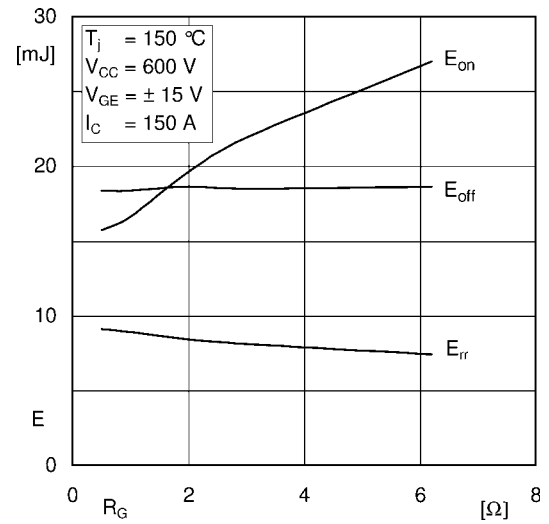


Fig. 4: Typ. turn-on /-off energy =  $f(R_G)$

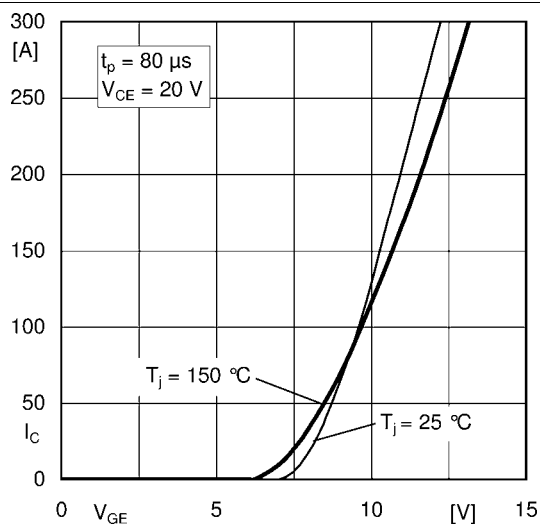


Fig. 5: Typ. transfer characteristic

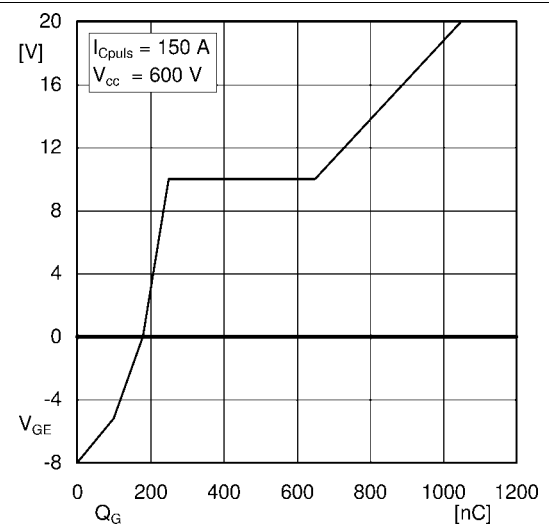


Fig. 6: Typ. gate charge characteristic

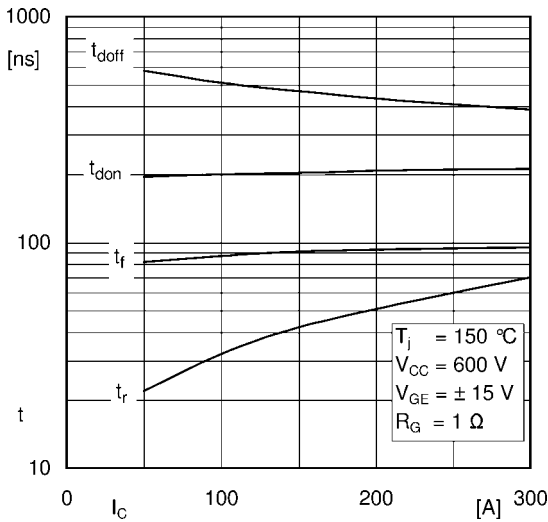


Fig. 7: Typ. switching times vs.  $I_C$

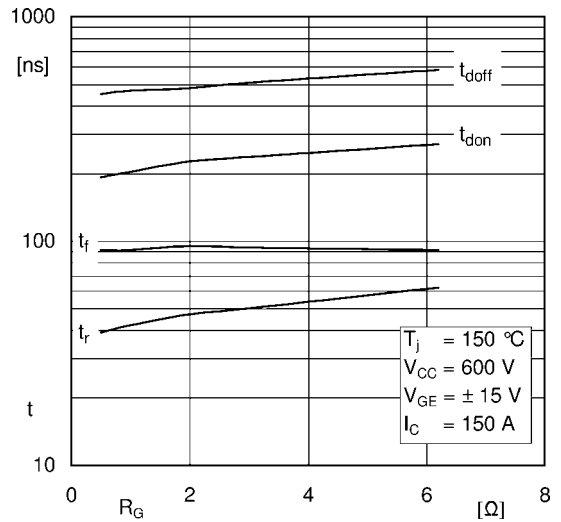


Fig. 8: Typ. switching times vs. gate resistor  $R_G$

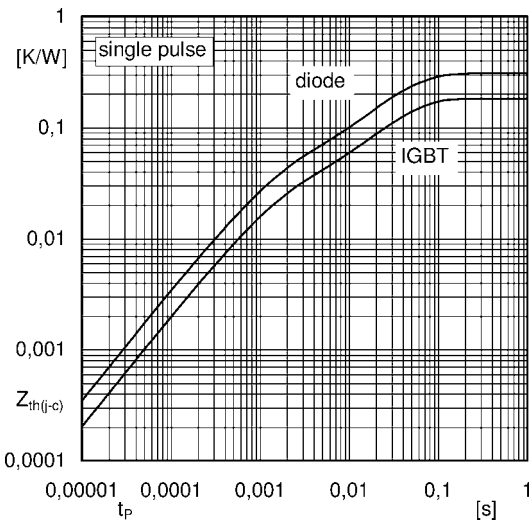


Fig. 9: Typ. transient thermal impedance

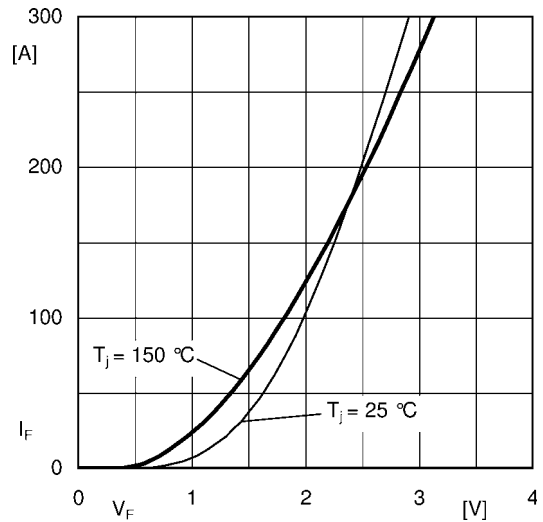


Fig. 10: Typ. CAL diode forward charact., incl.  $R_{CC+EE'}$

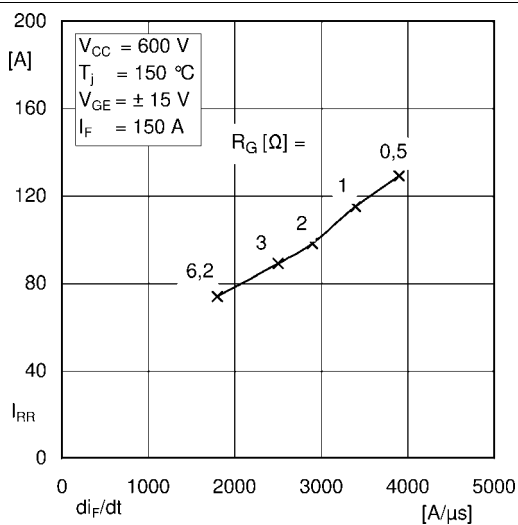


Fig. 11: Typ. CAL diode peak reverse recovery current

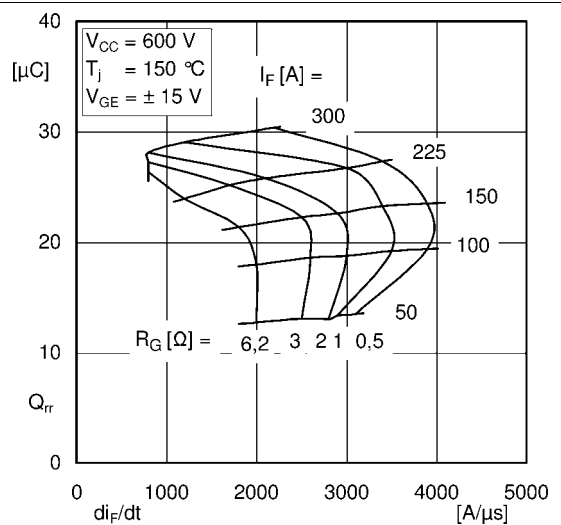


Fig. 12: Typ. CAL diode recovery charge

